Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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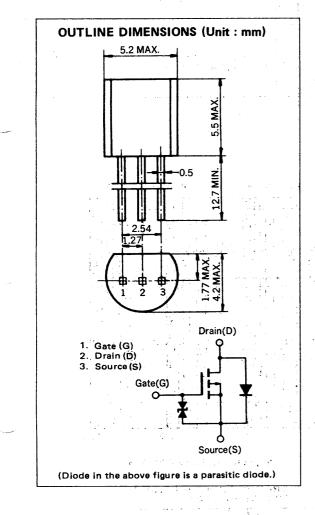
P1 98.2

DATA SHEET

RENESAS

MOS FIELD EFFECT TRANSISTOR Phase-out/Discontinued 2SJ198

P-CHANNEL MOS FET FOR SWITCHING



The 2SJ198 is a p-channel vertical type MOS FET switching device which can be directly driven from an IC operating with a 5 V single power supply. The device featuring low ON-state resistance is of the voltage drive type and thus is ideal for driving actuators such as motors, solenoids, and relays.

FEATURES

- Low ON-state resistance
 - $R_{DS(on)} = 2.5 \Omega MAX. at V_{GS} = -4 V, I_D = -0.5 A$
 - $R_{DS(on)} = 2.0 \Omega$ MAX. at $V_{GS} = -10$ V, $I_D = -0.5$ A
- Voltage drive at logic level (V_{GS} = -4 V) is possible.
- Bidirectional zener diode for protection is incorporated in between the Gate and the Source.

• Inductive loads can be driven without protective circuit thanks to the improved breakdown voltage between the Drain and Source.

Complementary to 2SK1484

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C)

			· · · ·	
CHARACTERISTIC	SYMBOL	RATINGS	UNIT	TEST CONDITIONS
Drain to Source Voltage	VDSS	-100	V	V _{GS} = 0
Gate to Source Voltage	V _{GSS}	∓20	ν.	V _{DS} = 0
Drain Current (DC)	ID(DC)	Ŧ0.5	Α	
Drain Current (pulse)	ID(pulse)	∓1.0	Α	$PW \leq 10 \text{ ms}$, Duty Cycle $\leq 50 \%$
Total Power Dissipation	PT.	750	mW	
Channel Temperature	T _{ch}	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

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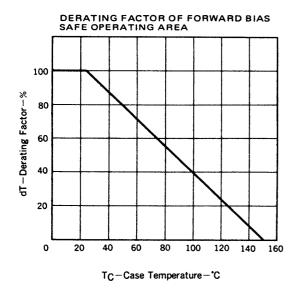


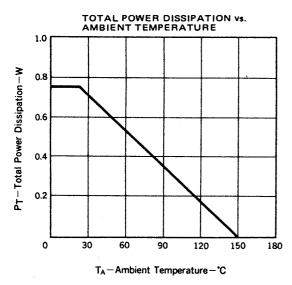
2SJ198

ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

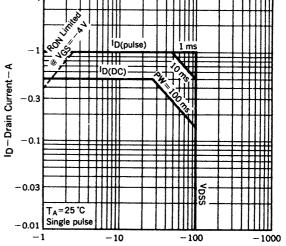
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Drain Cut-off Current	IDSS			-10	μA	$V_{DS} = -100 V, V_{GS} = 0$
Gate Leakage Current	IGSS			Ŧ10	μA	$V_{GS} = \pm 20 V, V_{DS} = 0$
Gate Cut-off Voltage	V _{GS(off)}	-1.0	-2.1	-3.0	V	$V_{DS} = -10 V, I_{D} = -1 mA$
Forward Transfer Admittance	ly _{fs} l	0.4	0.9		S	$V_{DS} = -10 V, I_{D} = -0.5 A$
Drain to Source On-State Resistance	R _{DS(on)1}		1.5	2.5	Ω	$V_{GS} = -4.0 V, I_D = -0.5 A$
Drain to Source On-State Resistance	R _{DS(on)2}		1.1	2.0	Ω	V _{GS} = -10 V, I _D = -0.5 A
Input Capacitance	Ciss		220		pF	V _{DS} =10 V, V _{GS} = 0, f = 1 MHz
Output Capacitance	Coss		85		pF	
Feedback Capacitance	C _{rss}		8		pF	
Turn-On Delay Time	^t d(on)		45		ns	V _{GS(on)} = –10 V, R _G = 10 Ω, V _{DD} = –25 V, I _D = –0.5 A, R _L = 50 Ω
Rise Time	t _r		36		ns	
Turn-Off Delay Time	^t d(off)		360		ns	
Fall Time	tf		90		ńs	

TYPICAL CHARACTERISTICS ($T_A = 25$ °C)

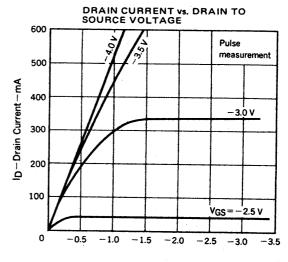




FORWARD BIAS SAFE OPERATING AREA

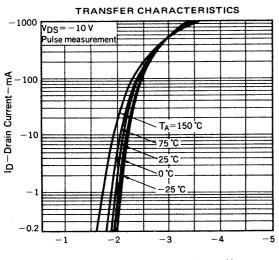


VDS-Drain to Source Voltage-V



VDS-Drain to Source Voltage-V

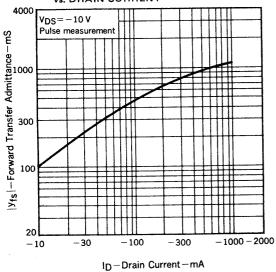
Phase-out/Discontinued



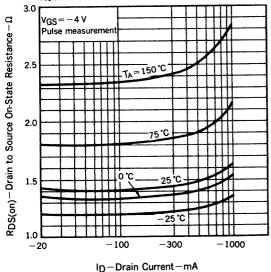
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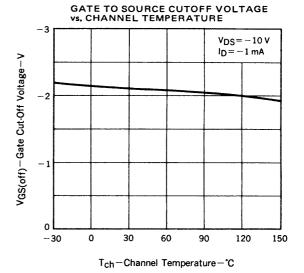
VGS-Gate to Source Voltage-V



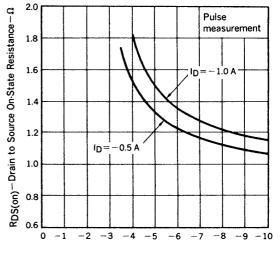


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



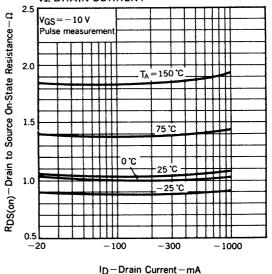


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

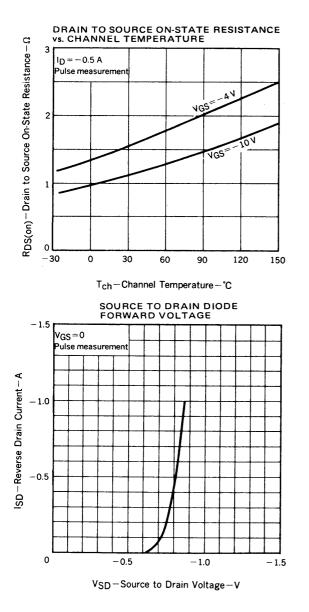


VGS-Gate to Source Voltage-V

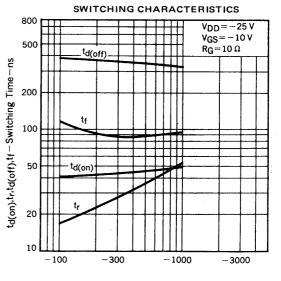
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



Phase-out/Discontinued

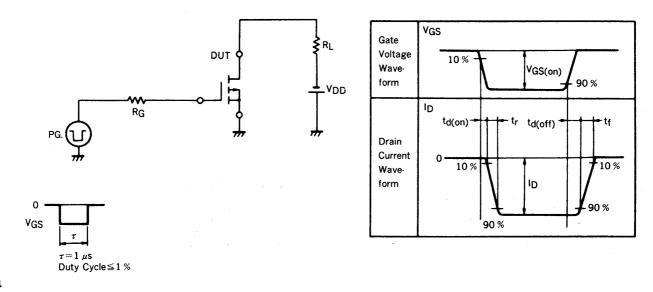


NEC



ID-Drain Current-mA

SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS







RECOMMENDED SOLDERING CONDITIONS

Solder this product under the following recommended conditions.

For soldering methods or soldering conditions other than those recommended in the table, please consult our NEC salespeople.

Insert type

ſ	Soldering method	Soldering conditions	Recommended condition code
	Wave soldering	Solder bath temperature: 260 °C max. Soldering time: 10 sec max.	

Phase-out/Discontinued

2SJ198

[MEMO]

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- Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
- Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
- Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.

M4 96.5